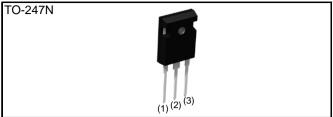


SCT2280KEHR

Automotive Grade N-channel SiC power MOSFET

V_{DSS}	1200V
R _{DS(on)} (Typ.)	280mΩ
I _D	14A
P_D	108W

●Outline



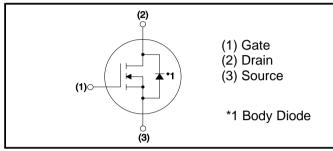
Features

- 1) Low on-resistance
- 2) Fast switching speed
- 3) Fast reverse recovery
- 4) Easy to parallel
- 5) Simple to drive
- 6) Pb-free lead plating; RoHS compliant
- 7) Qualified to AEC-Q101

Application

- Automobile
- Switch mode power supplies

●Inner circuit



Packaging specifications

Pack	age	TO-247N
	Packing	Tube
	Reel size (mm)	-
Typo	Tape width (mm)	-
Туре	Basic ordering unit (pcs)	30
	Packing code	C11
	Marking	SCT2280KE

●Absolute maximum ratings (T_a = 25°C)

Parameter	Symbol	Value	Unit	
Drain - Source voltage		V _{DSS}	1200	V
Continuous drain current	T _c = 25°C	I _D *1	14	А
	T _c = 100°C	I _D ^{*1}	10	А
Pulsed drain current		I _{D,pulse} *2	35	А
Gate - Source voltage (DC)		V _{GSS}	-6 to 22	V
Gate - Source surge voltage (T _{surge} < 300nsec)		$V_{\rm GSS_surge}^{*3}$	-10 to 26	V
Power dissipation (T _c = 25°C)		P _D	108	W
Junction temperature		T _j	175	°C
Range of storage temperature		T _{stg}	-55 to +175	°C

●Electrical characteristics (T_a = 25°C)

Parameter	Symbol	Conditions	Values			Unit
r arameter	Symbol	Conditions	Min.	Тур.	Max.	Offic
Drain - Source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V$, $I_D = 1mA$	1200	ı	ı	٧
Zero gate voltage drain current	I _{DSS}	$V_{DS} = 1200V, V_{GS} = 0V$ $T_{j} = 25^{\circ}C$ $T_{j} = 150^{\circ}C$	1 1	1 2	10	μΑ
Gate - Source leakage current	I_{GSS+}	$V_{GS} = +22V, V_{DS} = 0V$	ı	ı	100	nA
Gate - Source leakage current	I _{GSS-}	$V_{GS} = -6V, V_{DS} = 0V$	-	•	-100	nA
Gate threshold voltage	$V_{GS (th)}$	$V_{DS} = V_{GS}$, $I_D = 1.4 \text{mA}$	1.6	2.8	4.0	V

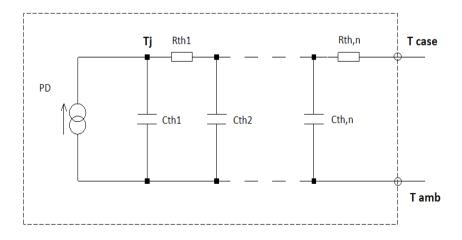
●Thermal resistance

Parameter	Symbol	Values			Unit
Farameter	Symbol	Min.	Тур.	Max.	Offic
Thermal resistance, junction - case	R_{thJC}	-	1.07	1.39	°C/W
Thermal resistance, junction - ambient	R_{thJA}	-	-	50	°C/W
Soldering temperature, wavesoldering for 10s	T _{sold}	-	-	265	°C

● Typical Transient Thermal Characteristics

Symbol	Value	Unit
R _{th1}	1.00E-01	
R _{th2}	6.62E-01	K/W
R _{th3}	3.04E-01	

Symbol	Value	Unit
C _{th1}	8.61E-04	
C _{th2}	2.84E-03	Ws/K
C _{th3}	5.59E-02	





•Electrical characteristics $(T_a = 25^{\circ}C)$

Parameter	Cumbal	Conditions	Values			Unit
r वावागि द्य ा	Symbol	Conditions	Min.	Тур.	Max.	Offic
		$V_{GS} = 18V, I_D = 4A$				
Static drain - source on - state resistance	R _{DS(on)} *4	$T_j = 25^{\circ}C$	-	280	364	mΩ
		T _j = 125°C	-	388	-	
Gate input resistance	R_{G}	f = 1MHz, open drain	-	17	-	Ω
Transconductance	g fs *4	$V_{DS} = 10V, I_D = 4A$	-	1.4	-	S
Input capacitance	C _{iss}	$V_{GS} = 0V$	-	667	-	
Output capacitance	C _{oss}	$V_{DS} = 800V$	-	27	-	pF
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	5	-	
Effective output capacitance, energy related	C _{o(er)}	$V_{GS} = 0V$ $V_{DS} = 0V$ to 500V	-	41	-	pF
Turn - on delay time	t _{d(on)} *4	$V_{DD} = 400V, V_{GS} = 18V$	-	19	-	
Rise time	t _r *4	I _D = 4A	-	19	-	
Turn - off delay time	t _{d(off)} *4	$R_L = 100\Omega$	-	47	-	ns
Fall time	t _f *4	$R_G = 0\Omega$	ı	29	-	
Turn - on switching loss	E _{on} *4	$V_{DD} = 600V, I_{D} = 4A$ $V_{GS} = 18V/0V$ $R_{G} = 0\Omega, L = 500\mu H$	-	57	-	1
Turn - off switching loss	E _{off} *4	*E _{on} includes diode reverse recovery	-	20	-	μJ

● Gate Charge characteristics (T_a = 25°C)

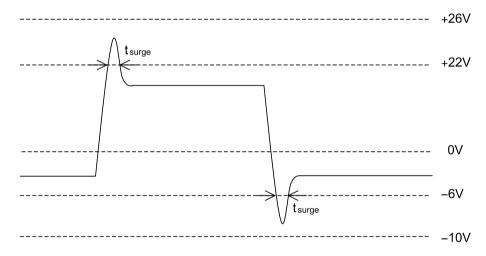
Parameter	Symbol	Conditions	Values			Unit
		Conditions	Min.	Тур.	Max.	Offic
Total gate charge	Q_g^{*4}	V _{DD} = 400V	-	36	-	
Gate - Source charge	Q _{gs} *4	I _D = 4A	-	9	-	nC
Gate - Drain charge	Q _{gd} *4	V _{GS} = 18V	-	12	-	
Gate plateau voltage	V _(plateau)	$V_{DD} = 400V, I_D = 4A$	-	9.8	-	V

●Body diode electrical characteristics (Source-Drain) (T_a = 25°C)

Parameter	Symbol	Conditions	Values			Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Offic
Inverse diode continuous, forward current	l _S *1	-T _c = 25°C	-	,	14	А
Inverse diode direct current, pulsed	I _{SM} *2		-	-	35	А
Forward voltage	V _{SD} *4	$V_{GS} = 0V$, $I_S = 4A$	-	4.0	-	V
Reverse recovery time	t _{rr} *4		-	22	-	ns
Reverse recovery charge	Q _{rr} *4	I _F = 4A, V _R = 400V di/dt = 160A/μs	-	21	-	nC
Peak reverse recovery current	I _{rrm} *4		-	2.0	-	А

^{*1} Limited only by maximum temperature allowed.

^{*3} Example of acceptable V_{GS} waveform



*4 Pulsed

^{*2} PW \leq 10 μ s, Duty cycle \leq 1%

Fig.1 Power Dissipation Derating Curve

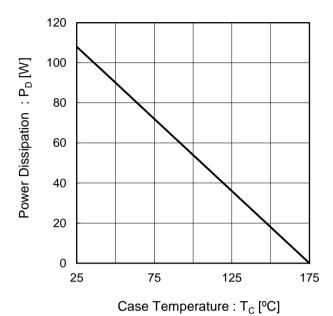


Fig.2 Maximum Safe Operating Area

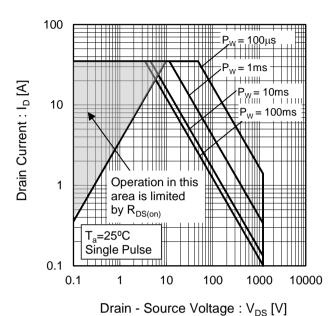
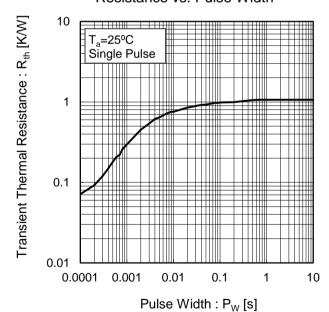


Fig.3 Typical Transient Thermal Resistance vs. Pulse Width



Datasheet SCT2280KEHR

Drain Current: I_D [A]

Drain Current: I_D [A]

Fig.4 Typical Output Characteristics(I)

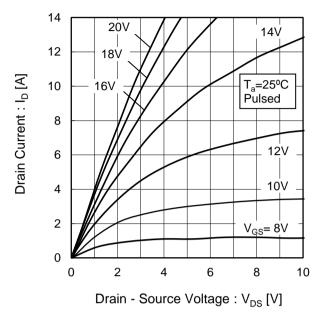
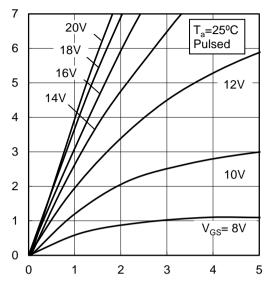
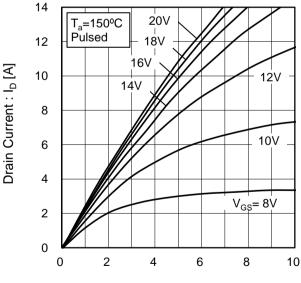


Fig.5 Typical Output Characteristics(II)



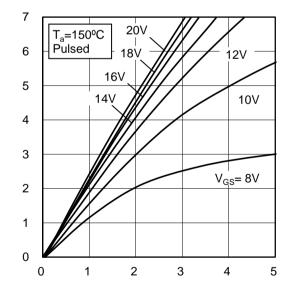
Drain - Source Voltage : V_{DS} [V]

Fig.6 T_i = 150°C Typical Output Characteristics(I)



Drain - Source Voltage: V_{DS} [V]

Fig.7 $T_j = 150^{\circ}C$ Typical Output Characteristics(II)



Drain - Source Voltage : V_{DS} [V]

Fig.8 Typical Transfer Characteristics (I)

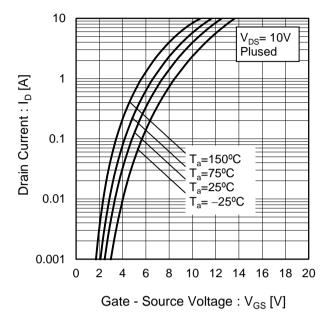


Fig.9 Typical Transfer Characteristics (II)

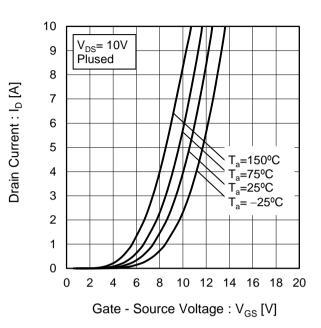


Fig.10 Gate Threshold Voltage vs. Junction Temperature

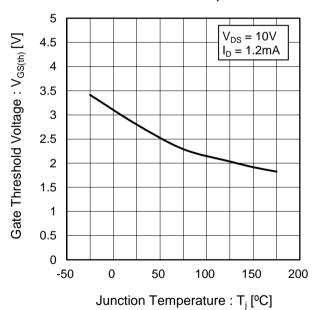


Fig.11 Transconductance vs. Drain Current

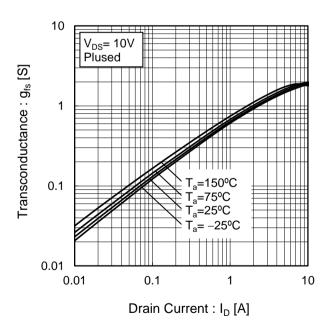


Fig.12 Static Drain - Source On - State Resistance vs. Gate Source Voltage

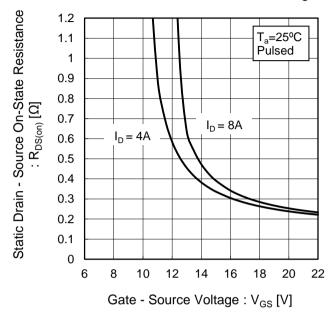


Fig.13 Static Drain - Source On - State Resistance vs. Junction Temperature

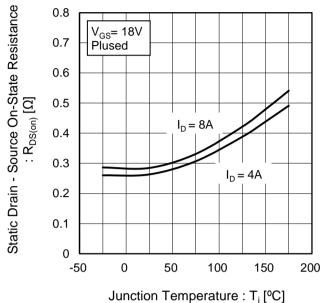


Fig.14 Static Drain - Source On - State Resistance vs. Drain Current

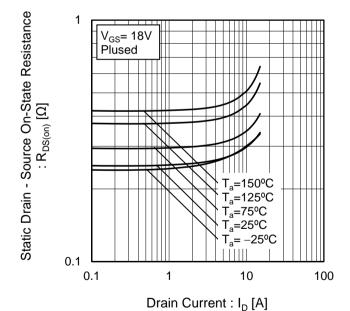


Fig.15 Typical Capacitance

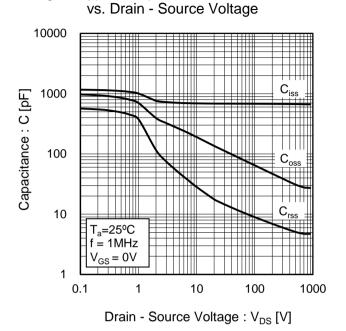
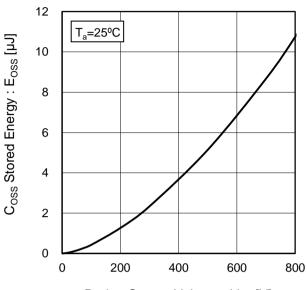


Fig.16 C_{OSS} Stored Energy



Drain - Source Voltage : V_{DS} [V]

Fig.17 Switching Characteristics

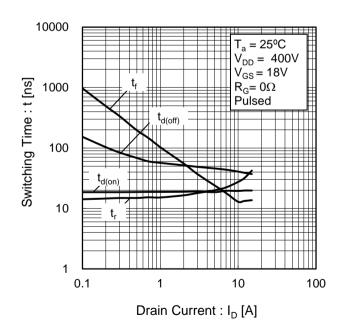


Fig.18 Dynamic Input Characteristics

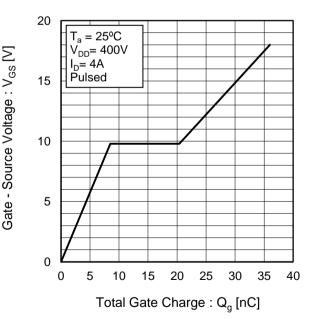


Fig.19 Typical Switching Loss vs. Drain - Source Voltage

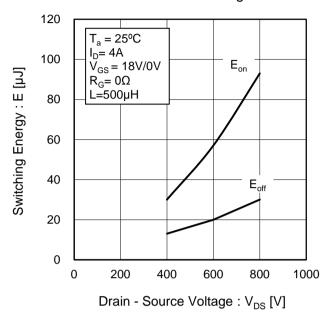


Fig.20 Typical Switching Loss vs. Drain Current

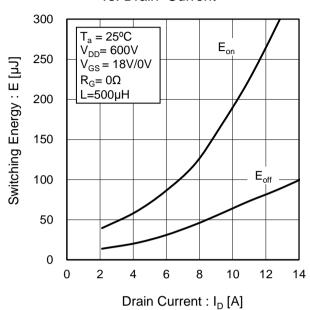
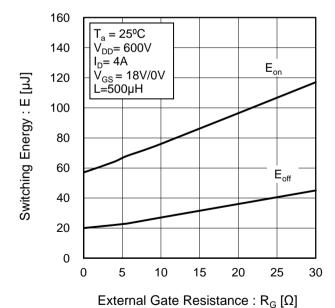


Fig.21 Typical Switching Loss vs. External Gate Resistance



•Electrical characteristic curves

Fig.22 Inverse Diode Forward Current vs. Source - Drain Voltage

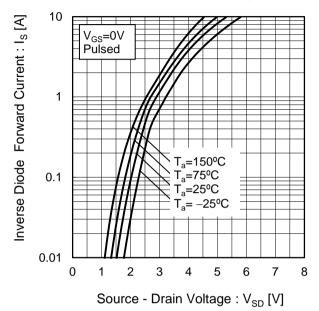
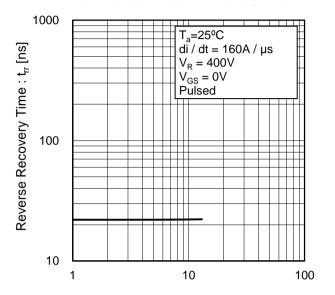


Fig.23 Reverse Recovery Time vs.Inverse Diode Forward Current



Inverse Diode Forward Current : I_S [A]

Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

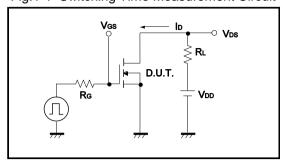


Fig.2-1 Gate Charge Measurement Circuit

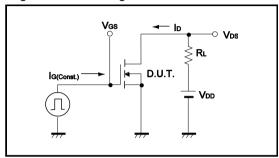


Fig.3-1 Switching Energy Measurement Circuit

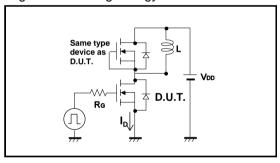


Fig.4-1 Reverse Recovery Time Measurement Circuit Fig.4-2 Reverse Recovery Waveform

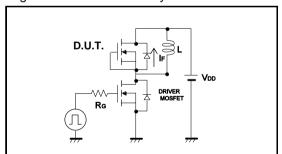


Fig.1-2 Switching Waveforms

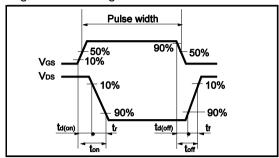


Fig.2-2 Gate Charge Waveform

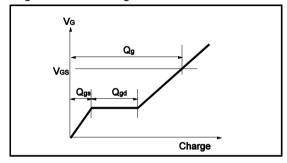
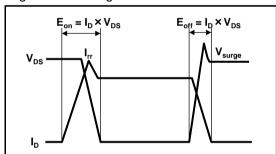
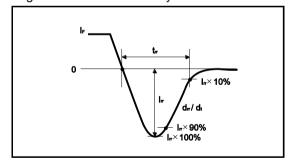


Fig.3-2 Switching Waveforms





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